

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
 For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	60	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _{RM}		
Average Rectified Output Current	I _O	900	mA
Average Peak Forward Current; D.C. = 50%	I _{FAV}	1,600	mA
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	15	A

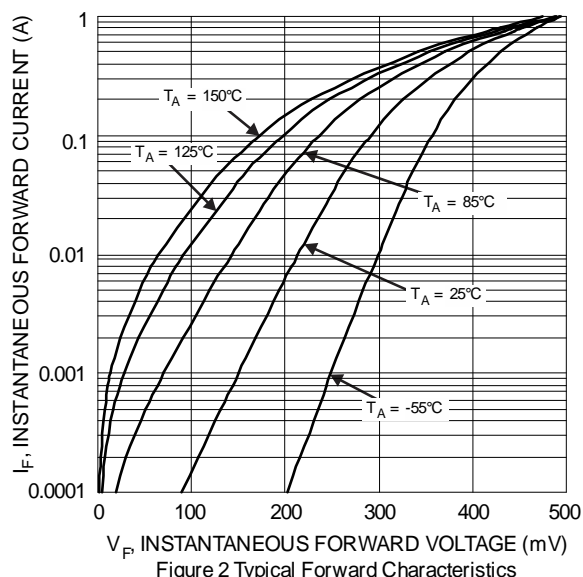
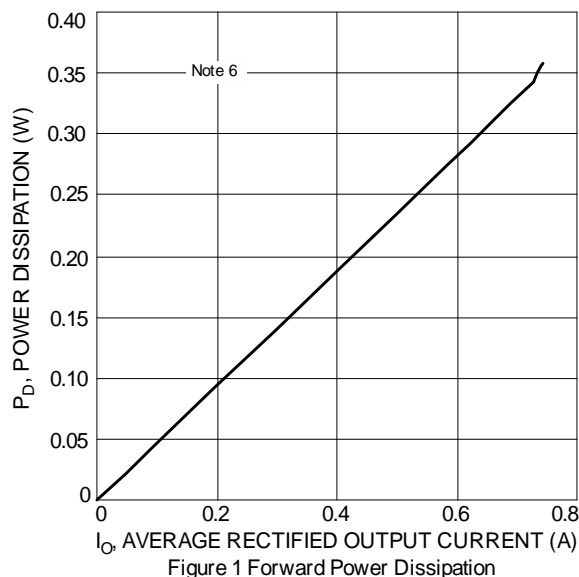
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P _D	500	mW
Typical Thermal Resistance	R _{θJA}	300	°C/W
Thermal Resistance Junction to Ambient Air (Note 5)			
Thermal Resistance Junction to Ambient Air (Note 6)			
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V _R	60	-	-	V	I _R = 1mA
Forward Voltage (Per Diode)	V _F	-	-	470 530 600 740	mV	I _F = 500mA I _F = 750mA I _F = 1000mA I _F = 1500mA
Leakage Current (Note 7)	I _R	-	-	100	μA	V _R = 45V, T _J = +25°C
Total Capacitance	C _T	-	19	-	pF	V _R = 25V, f = 1MHz
Reverse Recovery Time	t _{rr}	-	16	-	ns	I _F = I _R = 10mA, I _{RR} = 0.1 x I _R R _L = 100Ω

Notes: 5. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at <http://www.diodes.com>.
 6. Part mounted on 1 inch sq. 2oz copper pad.
 7. Short duration pulse test used to minimize self-heating effect.



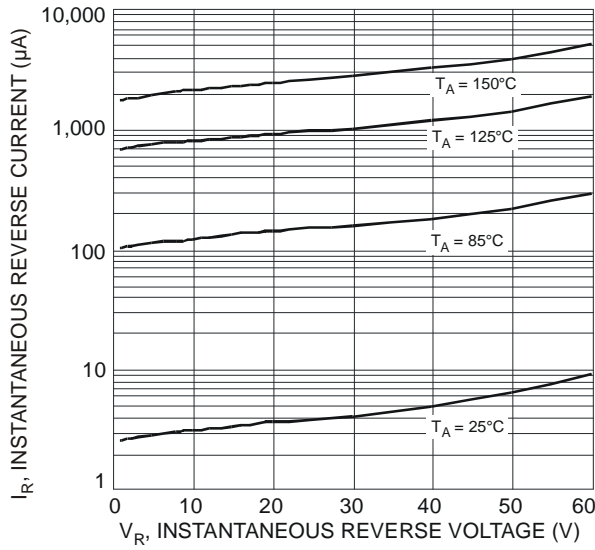


Fig. 3 Typical Reverse Characteristics

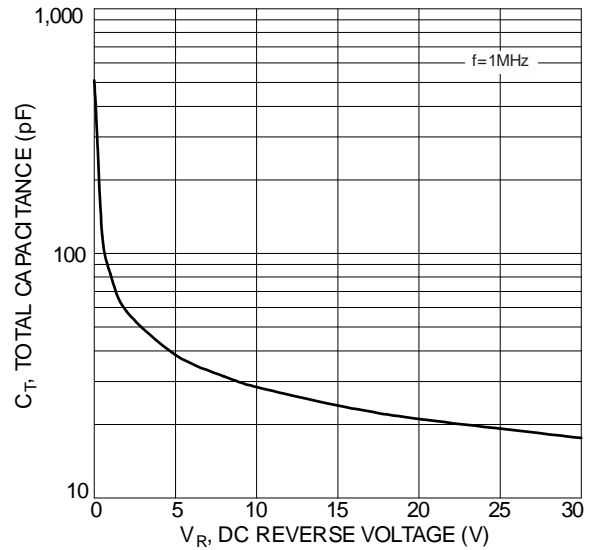


Fig. 4 Total Capacitance vs. Reverse Voltage

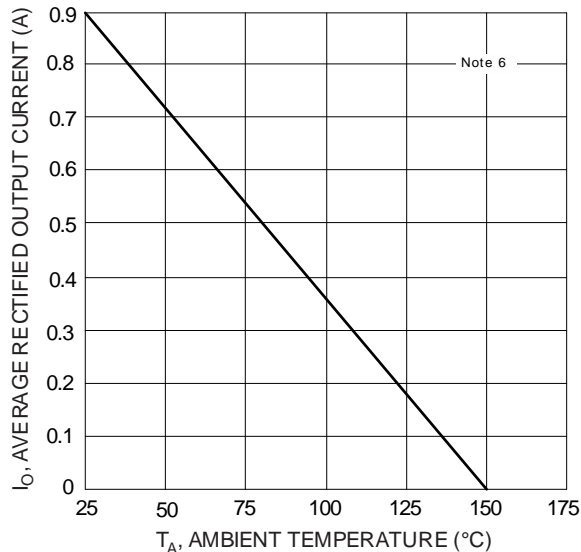


Fig. 5 Forward Current Derating Curve

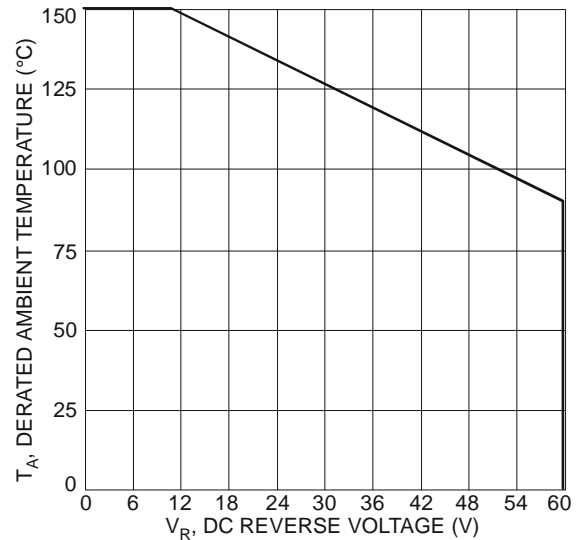
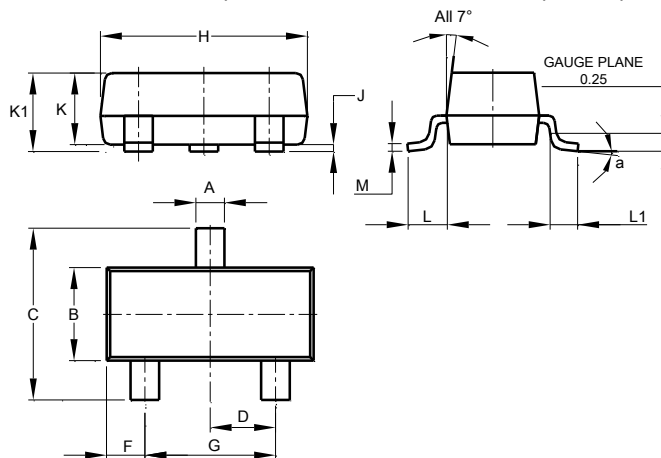


Fig. 6 Operating Temperature Derating

Package Outline Dimensions

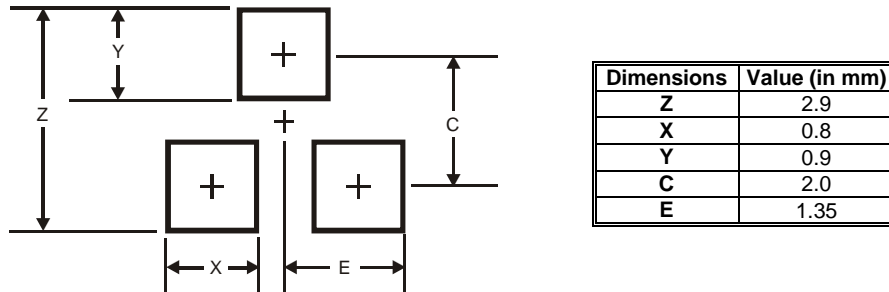
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	8°		
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



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